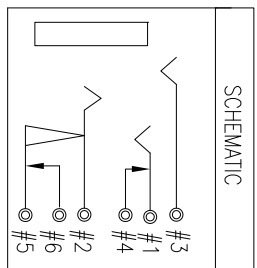
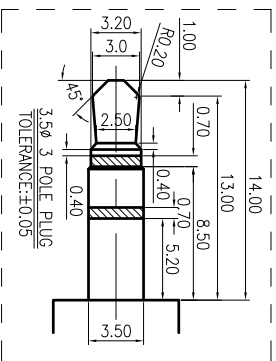


RECOMMENDED P.C.B. LAYOUT T=1.20  
TOP VIEW (TOLERANCE: ±0.05)



REV.	ECN NO OR DESCRIPTION	REVISED	DATE
A	PRODUCED RELEASED	JUNHUA	2009/07/14
B	ECN:C100175Modify Shell	REX	2010/07/06
C	ECN:C10149-3 Modify Plating Au Area	BILLY	2010/05/23

- SPECIFICATIONS:
- ELECTRICAL CHARACTERISTICS:
    - RATING: 36V AC, 1A DC.
    - CONTACT RESISTANCE: 50m Ω MAX.
    - DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR ONE MINUTE.
    - INSULATION RESISTANCE: 100MΩ MIN. MEASURED BY 500 VDC
  - MECHANICAL CHARACTERISTICS:
    - INSERTION FORCE : 0.4~3.0 KGF
    - WITHDRAWAL FORCE : 0.3~2.0 KGF
  - LIFE TEST: 5,000 CYCLES MIN.
  - OTHER GENERAL SPEC. TO REFER "2SJ2285 SERIES SPEC".
  - TO CONFORM TO THE SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.
  - HALOGEN PRODUCT IDENTIFICATION MARK ON JACK: ○
  - HALOGEN PRODUCT IDENTIFICATION LABEL ON PACKAGING:
  - FOR REFLOW SOLDERING LEAD-FREE PROCESS.
  - PACKAGING:TAPE&REEL.



I	MYLAR	1	THINKNESS 0.075T	YELLOW
H	SHIELD	1	COPPER ALLOY 0.20T	NI PLATING
G	TRANSFER TERMINAL	1	COPPER ALLOY 0.20T	△ Gold flash on contact area and Solder fall off over Nickel Plating
F	BREAK TERMINAL	1	COPPER ALLOY 0.20T	Gold Flash
E	RING	1	COPPER ALLOY 0.20T	△ Gold flash on contact area and Solder fall off over Nickel Plating
D	SHUNT	1	COPPER ALLOY 0.20T	Gold Flash
C	TIP	1	COPPER ALLOY 0.25T	△ Gold flash on contact area and Solder fall off over Nickel Plating
B	EARTH	1	COPPER ALLOY 0.20T	Gold Flash
A	BODY	1	HIGH TEMP.THERMOPLASTIC UL 94V-0	BLACK
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
UNLESS OTHERWISE SPECIFIED TOLERANCES				
Singatron Enterprise Co., Ltd. 信音企業股份有限公司				
TITLE: 3.50 PHONE JACK				
DWN	REV: 2011.5.27	PART NO. 2SJ2284-000192		
CHKD	SCALE 3:1	UNIT: mm		
APVD	DATE 2011.5.27	SIZE: A3	SHEET: 10F1	REV: C
CUSTOMER COPY				